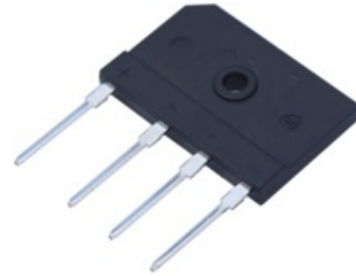


50A Single Phase Bridge Rectifier

Features

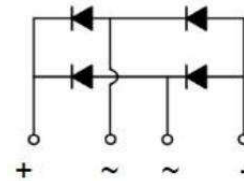
- Ideal for printed circuit boards
- High surge current capability
- Reverse Voltage : 50 to 1000V
- Forward Current : 50A
- High temperature soldering : 260°C/10s at terminals



GBJ

Applications

- Single phase rectifiers for power supplies
- Industrial automation equipment
- Input rectifiers for inverter



Maximum Ratings and Electrical characteristics

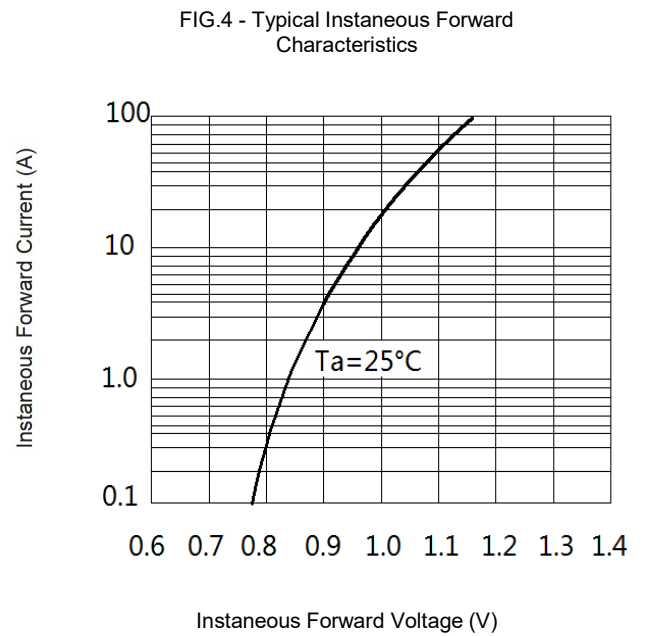
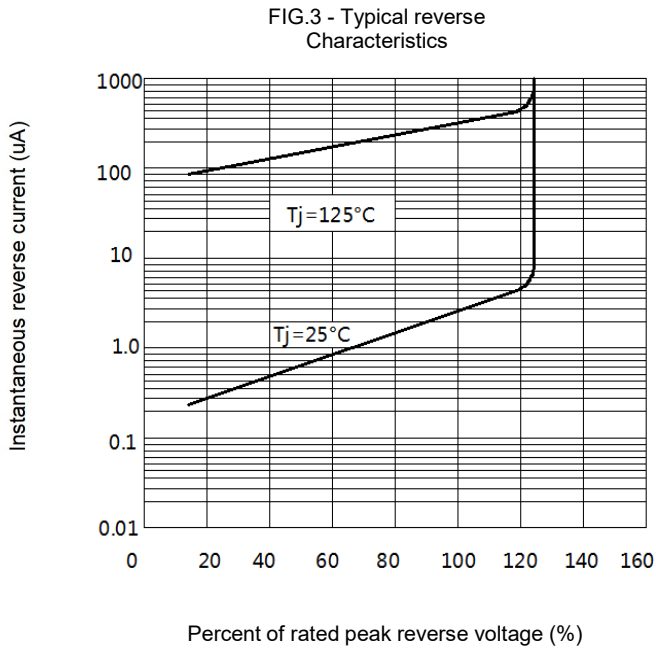
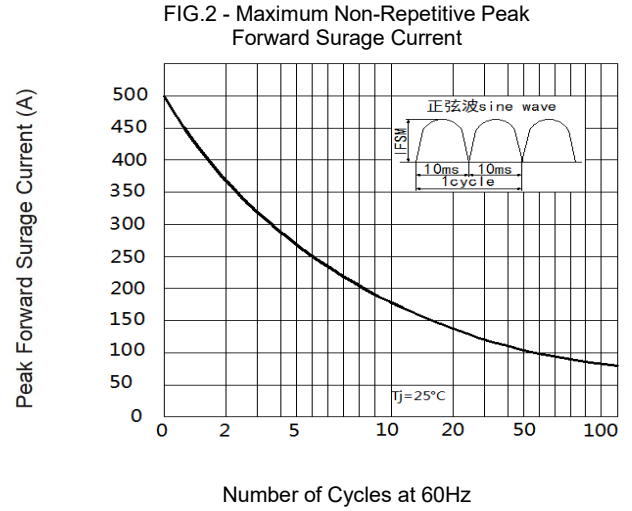
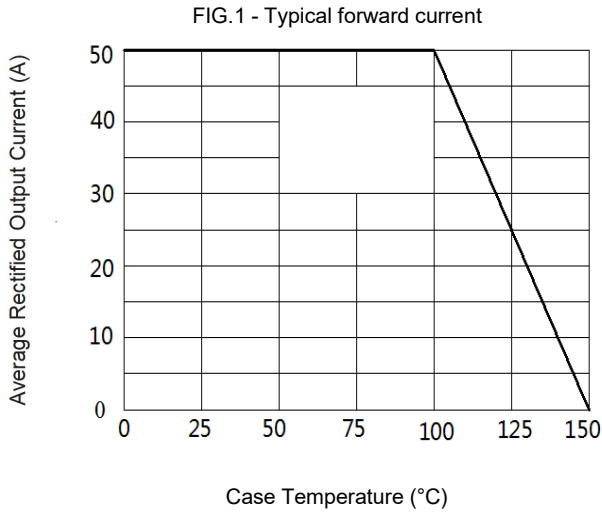
Ratings at 25 °C ambient temperature unless otherwise specified. Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

Parameter	Symbol	GBJ 50005	GBJ 5001	GBJ 5002	GBJ 5004	GBJ 5006	GBJ 5008	GBJ 5010	Unit
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current @ $T_C=100^{\circ}C$ with heatsink (Note 1)	$I_{F(AV)}$	50							A
Peak Forward Surge Current 8.3mS single half sine wave superimposed on rated load(JEDEC method)	I_{FSM}	500							A
Maximum Instantaneous Forward Voltage @25.0A	V_F	1.1							V
Maximum DC Reverse Current at Rated DC Blocking Voltage	$T_A=25^{\circ}C$	10							μA
	$T_A=125^{\circ}C$	500							
Typical Thermal Resistance (Note 1)	$R_{\theta JC}$	1.5							$^{\circ}C/W$
Operating Junction and Storage Temperature Range	T_J, T_{STG}	(-55 to +150)							$^{\circ}C$

Notes:

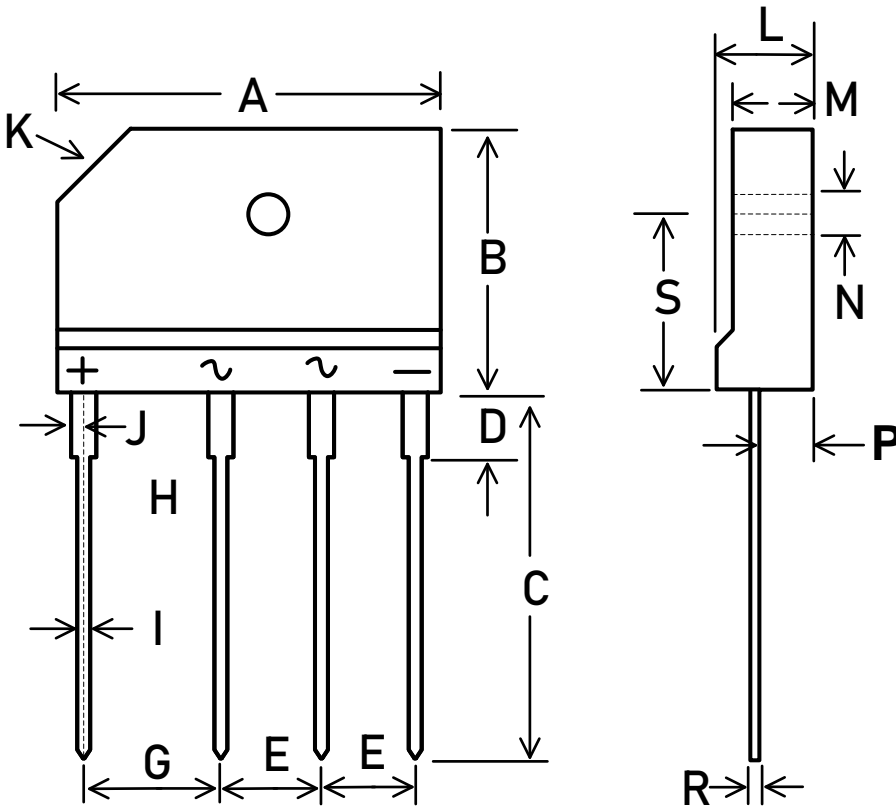
1. Device mounted on 300mm*300mm*1.6mm cu plate heatsink.

Ratings and Characteristic Curves ($T_A=25^{\circ}\text{C}$ unless otherwise noted)



Package Outlines (Dimensions in mm)

Plastic surface mounted package(GBJ)



Symbol	Millimeter	
	Min.	Max.
A	29.70	30.3
B	19.70	20.3
C	17.00	18.00
D	3.80	4.20
E	7.30	7.70
G	9.80	10.20
H	2.00	2.40
I	0.90	1.10
J	2.30	2.70
K	3.0x45°	
L	4.40	4.80
M	3.40	3.80
N	3.10	3.40
P	2.50	2.90
R	0.60	0.80
S	10.80	11.20

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